

General Description

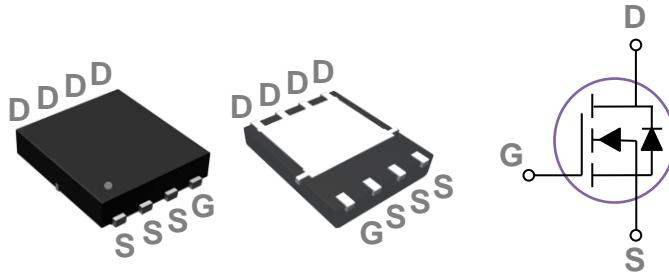
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
40V	0.90mΩ	270A

Features

- 40V, 270A, RDS(ON) = 0.90mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

PPAK5X6 Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _{Gs}	Gate-Source Voltage	±20	V
I _D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	270	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	170	A
I _{DM}	Drain Current – Pulsed ¹	1080	A
P _D	Power Dissipation ($T_c=25^\circ\text{C}$)	176	W
	Power Dissipation – Derate above 25°C	1.41	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	0.71	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250µA	40	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =40V, V _{GS} =0V, T _J =25°C	---	---	1	µA
		V _{DS} =32V, V _{GS} =0V, T _J =100°C	---	---	10	µA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DSON}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =25A	---	0.75	0.90	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250µA	2.6	3.2	4	V

Dynamic and switching Characteristics²

Q _g	Total Gate Charge	V _{DS} =20V, V _{GS} =10V, I _D =80A	---	82	125	nC
Q _{gs}	Gate-Source Charge		---	16	25	
Q _{gd}	Gate-Drain Charge		---	23	35	
T _{d(on)}	Turn-On Delay Time	V _{DD} =20V, V _{GS} =10V, R _G =6Ω I _D =80A	---	20	30	ns
T _r	Rise Time		---	30	45	
T _{d(off)}	Turn-Off Delay Time		---	30	45	
T _f	Fall Time		---	35	55	
C _{iss}	Input Capacitance		---	4800	7200	pF
C _{oss}	Output Capacitance	V _{DS} =20V, V _{GS} =0V, F=1MHz	---	2000	3000	
C _{rss}	Reverse Transfer Capacitance		---	165	250	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1.3	---	Ω

Guaranteed Avalanche Energy

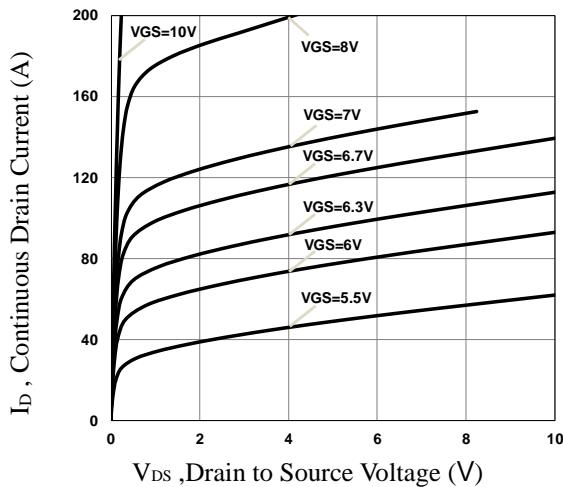
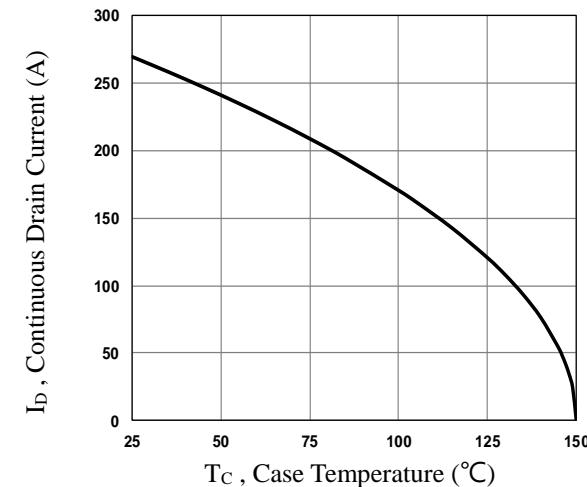
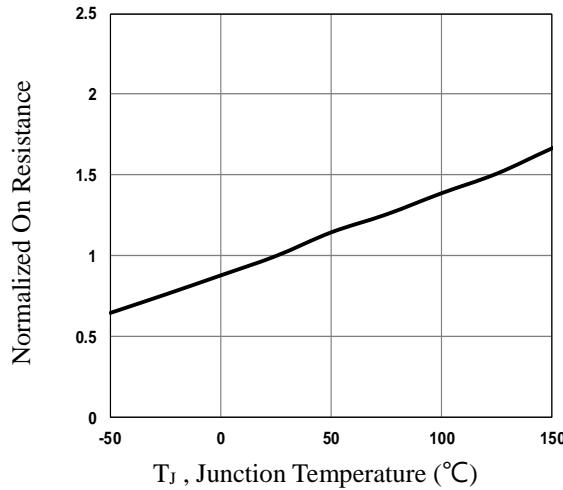
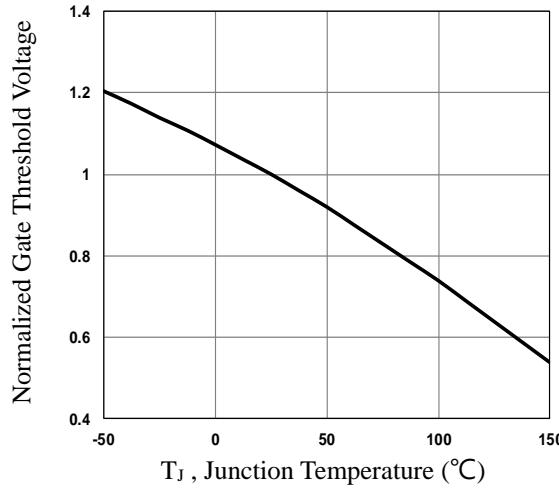
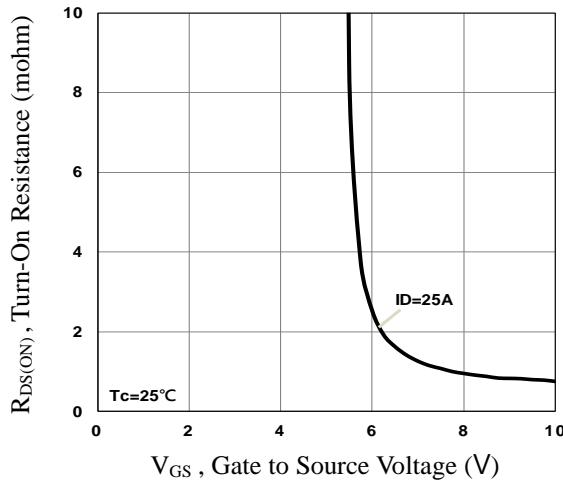
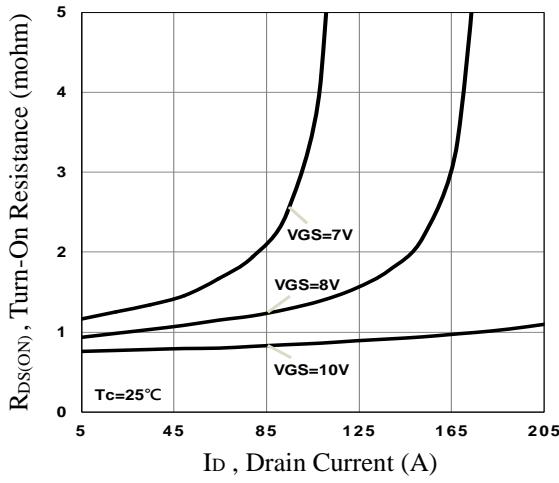
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy	V _{DD} =40V, L=0.1mH, I _{AS} =86A	370	---	---	mJ

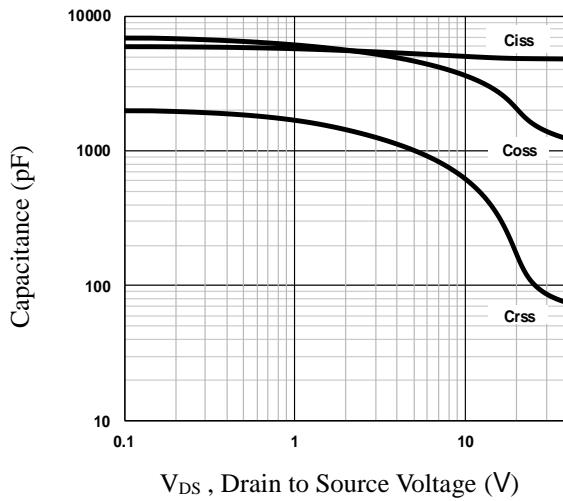
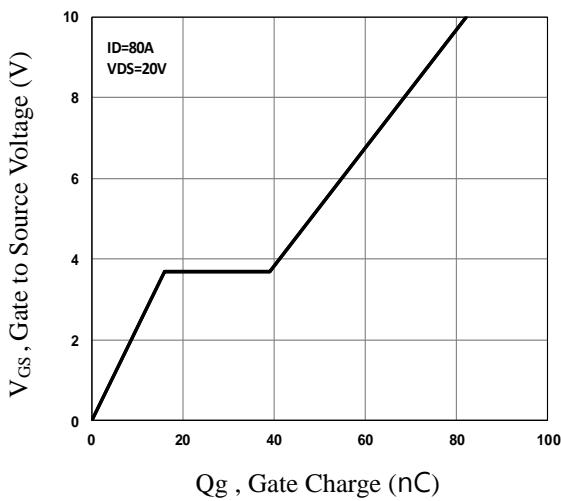
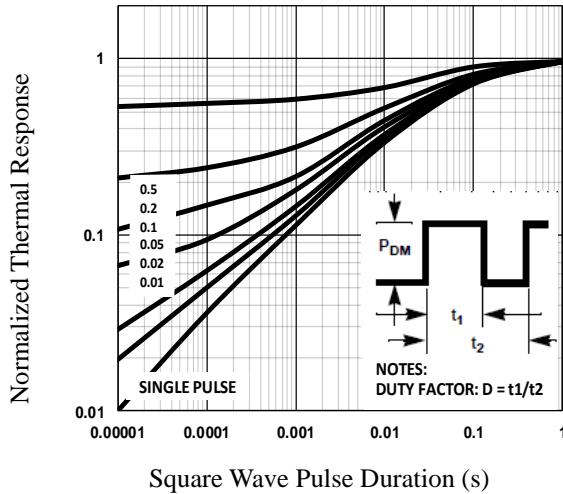
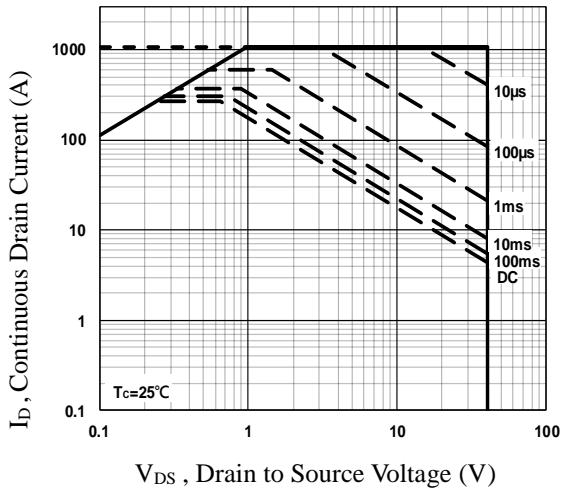
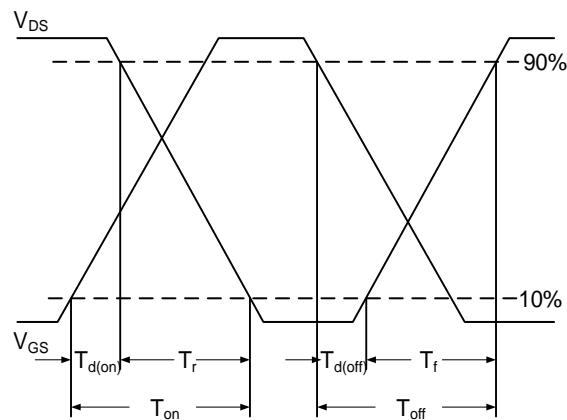
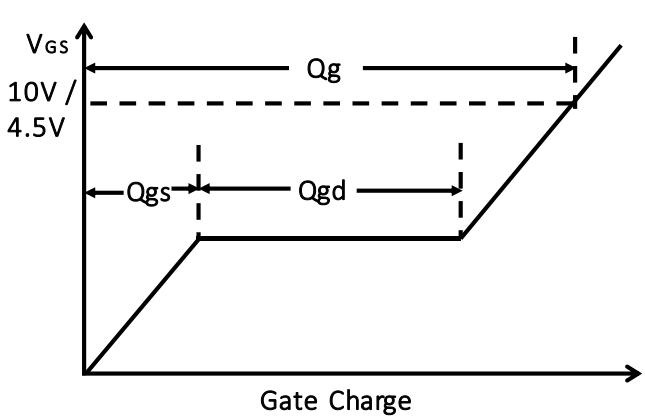
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	270	A
I _{SM}	Pulsed Source Current		---	---	540	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _s =1A, T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time	V _R =20V, I _s =10A di/dt=100A/µs, T _J =25°C	---	65	---	ns
Q _{rr}	Reverse Recovery Charge		---	105	---	nC

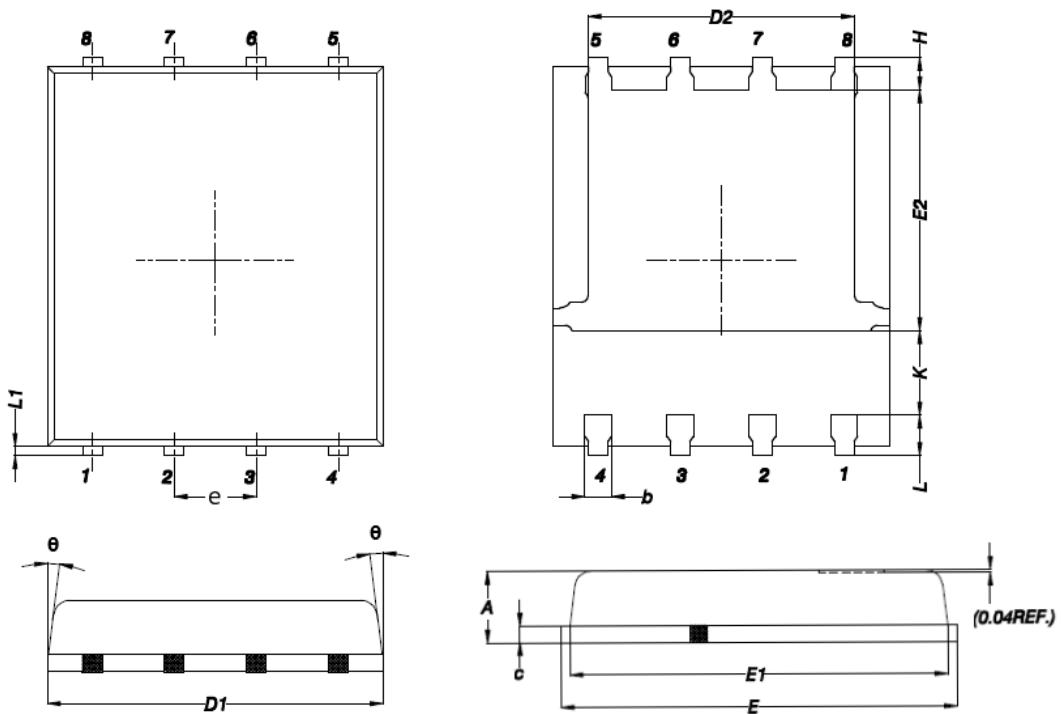
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. Essentially independent of operating temperature.

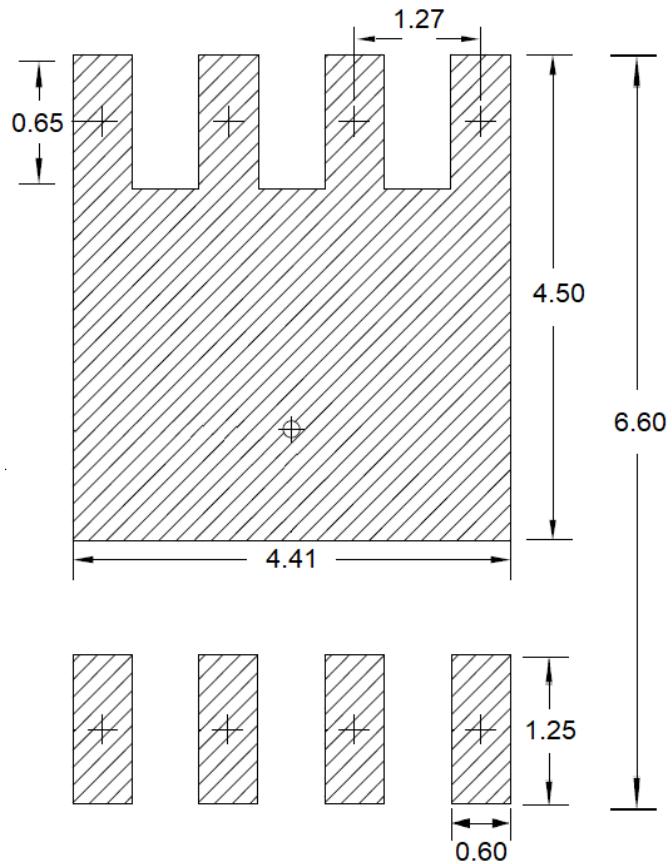

Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized $R_{DS(on)}$ vs. T_j

Fig.4 Normalized V_{th} vs. T_j

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D


Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 Gate Charge Waveform

PPAK5x6 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.200	0.850	0.047	0.031
b	0.510	0.300	0.020	0.012
C	0.300	0.200	0.012	0.008
D1	5.400	4.800	0.212	0.189
D2	4.310	3.610	0.170	0.142
E	6.300	5.850	0.248	0.230
E1	5.960	5.450	0.235	0.215
E2	3.920	3.300	0.154	0.130
e	1.27BSC		0.05BSC	
H	0.650	0.380	0.026	0.015
K	---	1.100	---	0.043
L	0.710	0.380	0.028	0.015
L1	0.250	0.050	0.009	0.002
θ	12°	0°	12°	0°

PPAK5X6 RECOMMENDED LAND PATTERN

unit : mm